



Power Resistor for Mounting onto a Heatsink Thick Film Technology

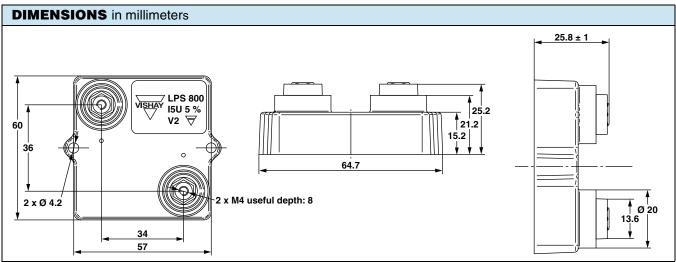


FEATURES

- 800 W at 85 °C bottom case temperature
- Wide resistance range: 0.3 Ω to 900 k Ω E24 series



- · Non inductive
- Easy mounting
- Low thermal radiation of the case
- Compliant to RoHS directive 2002/95/EC



Note

MECHANICAL SPECIFICATIONS

Mechanical Protection Insulated case UL 94 V-0

Resistive Element Thick film
Substrate Alumina
End Connections Screws M4

Tightening Torque

 $\begin{array}{lll} \textbf{- On Connections} & 2 \text{ Nm} \\ \textbf{- On Heatsink} & 2 \text{ Nm} \\ \textbf{Maximum Torque} & 2.5 \text{ Nm} \\ \textbf{Weight} & 83 \text{ g} \pm 10 \text{ \%} \\ \end{array}$

ENVIRONMENTAL SPECIFICATIONS

Temperature Range - 55 °C to 175 °C **Climatic Category** 55/175/56

ELECTRICAL SPECIFICATIONS					
Resistance Range	$0.3~\Omega$ to $900~\text{k}\Omega$				
Tolerances (Standard)	± 1 % to ± 10 %				
Power Rating and Thermal Resistance	800 W at + 85 °C bottom case temperature $R_{TH (j-c)}$: 0.112 °C/W				
Temperature Coefficient - 55 °C/175 °C IEC 60115-1 Standard	R ≤ 1 <i>U</i> : ± 500 ppm/°C 1 <i>U</i> < R ≤ 10 <i>U</i> : ± 300 ppm/°C 10 <i>U</i> < R: ± 150 ppm/°C				
Limiting Element Voltage U _L	5 kV				
Dielectric Strength IEC 60115-1, 1 min, 10 mA max.	7 kV _{RMS} or 12 kV _{RMS}				
Insulation Resistance	$\geq 10^4 \ \text{M}\Omega$				
Inductance	≤ 0.1 μH				
Critical Resistance	31.25 kΩ				

[•] Tolerances unless stated: ± 0.2 mm

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PERFORMANCE					
TESTS	CONDITIONS	REQUIREMENTS			
Momentary Overload	IEC 60115-1 1.5 x $P_r/10$ s $U_{\text{max.}} \le U_L = 5000 \text{ V}$	± (0.25 % + 0.05 Ω)			
Rapid Temperature Change	IEC 60115-1/IEC 60068-2-14 Test Na 50 cycles - 55 °C to + 175 °C	$\pm (0.5 \% + 0.05 \Omega)$			
Load Life	IEC 60115-1 1000 h (90/30) P _r at 85 °C	± (0.5 % + 0.05 Ω)			
Humidity (Steady State)	IEC 60115-1 56 days RH 95 %/40 °C	$\pm (0.5 \% + 0.05 \Omega)$			
Vibration	MIL STD 202 Method 204 Cond. D (10 g; 5/500 Hz)	± (0.25 % + 0.05 Ω)			
Climatic Sequence	natic Sequence IEC 60115-1 (55/175/56)				

RECOMMENDATIONS FOR MOUNTING ONTO A HEATSINK

- Surfaces in contact must be carefully cleaned.
- The heatsink must have an acceptable flatness: From 0.05 mm to 0.1 mm/100 mm.
- Roughness of the heatsink must be around 6.3 µm. In order to improve thermal conductivity, surfaces in contact (alumina, heatsink) should be coated with a silicone grease (type SI 340 from Rhône-Poulenc or Dow 340 from Dow Corning) or a thermal film (type Q Pad II) easier and faster to install than the grease.
- The fastening of the resistor to the heatsink is under pressure control of two screws tightened at 2 Nm for full power availability.

Tightening Torque on Heatsink	LPS 800	
	2 Nm	

• The following accessories are supplied with each product: 2 screws CHC M4 * 25 class 8.8 and 2 M4 contact lock washers for heatsink mounting,

> 2 screws TH M4 * 6/6 and 2 M4 contact lock washers for connections.

CHOICE OF THE HEATSINK

The user must choose the heatsink according to the working conditions of the component (power, room temperature). Maximum working temperature must not exceed 175 °C. The dissipated power is simply calculated by the following ratio:

$$P \,=\, \frac{\Delta T}{[\,R_{TH\,\,(j\,\text{-}\,c)} + R_{TH\,\,(c\,\text{-}\,a)}\,]} \label{eq:parameters}$$

P: Expressed in W

ΔΤ: Difference between maximum working temperature and room temperature

Thermal resistance value measured between resistive layer and outer side of the resistor. It is the thermal R_{TH (i - c)}: resistance of the component: (see specifications environmental paragraph).

Thermal resistance value measured between outer side of the resistor and room temperature. It is the thermal $R_{TH (c-a)}$: resistance of the thermal interface, the heatsink (type, shape) and the quality of the fastening device.

Example:

 $R_{TH\ (c-a)}$ for LPS 800 power dissipation 180 W at + 50 °C room temperature.

$$\begin{array}{l} \Delta T \leq 175 \ ^{\circ}C \ -\ 50 \ ^{\circ}C \ =\ 125 \ ^{\circ}C \\ R_{TH\ (j\ -\ c)} \ +\ R_{TH\ (c\ -\ a)} \ =\ \frac{\Delta T}{P} \ =\ \frac{125}{180} \ =\ 0.69 \ ^{\circ}C/W \\ R_{TH\ (j\ -\ c)} \ =\ 0.112 \ ^{\circ}C/W \end{array}$$

 $R_{TH (c-a)} = 0.69 \, ^{\circ}C/W - 0.112 \, ^{\circ}C/W = 0.578 \, ^{\circ}C/W$

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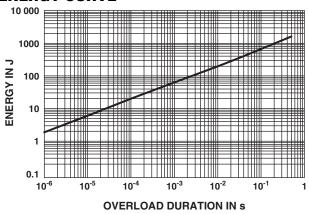
OVERLOADS

In any case the applied voltage must be lower than $U_{\rm L}$ = 5000 V.

Short time overload: 1.5 x P_r/10 s

Accidental overload: The values indicated on the following graph are applicable to resistors in air or mounted onto a heatsink.

ENERGY CURVE



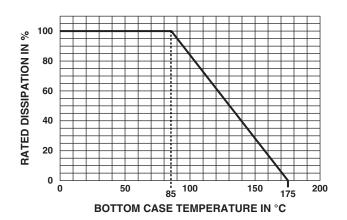
MARKING

Series, style, ohmic value (in Ω), tolerance (in %), manufacturing date, Vishay Sfernice trademark.

POWER RATING

The temperature of the case should be maintained within the limits specified in the following figure.

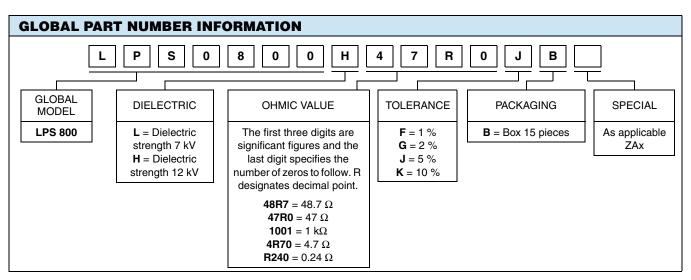
To optimize the thermal conduction, contacting surfaces should be coated with silicone grease or thermal film, and heatsink mounting screws tightened to 2 Nm.



PACKAGING

Box of 15 units

ORDERING I	NFORMATIC	N				
LPS	800	100 k Ω	± 1 %	xxx	BO15	е
MODEL	STYLE	RESISTANCE VALUE	TOLERANCE	CUSTOM DESIGN	PACKAGING	LEAD (Pb)-FREE
			± 1 %	Optional		
			± 2 %	on request:		
			± 5 %	Special TCR,		
			± 10 %	shape etc.		







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